Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
100V	1.3mΩ@10V	350A



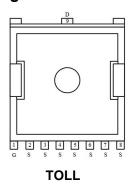
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

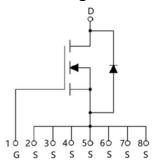
Applications

- PWM Application
- Hard switched and high frequency circuits
- Power Management

Package



Circuit diagram



Marking



SP010N01BLGHTO: Product code
**: Week code

Order Information

Device	Package	Unit/Tape
SP010N01BLGHTO	TOLL	2000

SP010N01BLGHTO

100V N-Channel Power MOSFET

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Tc=25°C)	I _D	350	Α
Continuous Drain Current (Tc=100°C)	I _D	235	Α
Pulsed Drain Current	I _{DM}	1400	Α
Single Pulse Avalanche Energy ¹	Eas	2116	mJ
Power Dissipation (Tc=25°C)	P _D	370	W
Thermal Resistance Junction-to-Case	R _{eJC}	0.34	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	$^{\circ}$
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$

Electrical characteristics (Ta=25°C, unless otherwise noted)

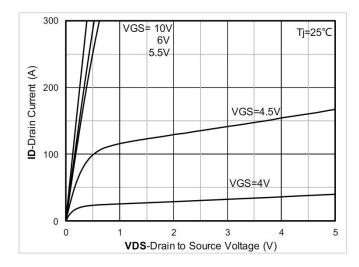
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics					•	•
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA	100	110	-	V
Drain Cut-Off Current	I _{DSS}	VDS=80V , VGS=0V , TJ=25℃	-	-	1	μΑ
Gate Leakage Current	I _{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	VGS=VDS , ID =250uA	2	3	4	V
Drain-Source ON Resistance	R _{DS(ON)}	VGS=10V , ID=20A	-	1.3	1.6	mΩ
Dynamic Characteristics				•		
Input Capacitance	Ciss		-	14071	-	
Output Capacitance	Coss	VDS=50V , VGS=0V , f=1MHz	-	2241	-	pF
Reverse Transfer Capacitance	C _{rss}		-	37	-	
Total Gate Charge	Qg	VDS=50V , VGS=10V , ID=125A	-	200	-	nC
Gate-Source Charge	Q _{gs}		-	54	-	
Gate-Drain Charge	Q _{gd}	VD3-30V , VG3-10V , ID-123A	-	35	-	
Switching Characteristics					•	
Turn-On Delay Time	t _{d(on)}		-	24	-	
Rise Time	tr		-	73	-	nS
Turn-Off Delay Time	t _{d(off)}	VDD=50V, VGS=10V , RG=1.6Ω,	-	86	-	
Fall Time	t _f	ID=125A	-	27	-	
Drain-Source Body Diode Characteris	stics					
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	ls		-	-	350	Α
Reverse Recovery Time	Trr	L =1004 di/dt=1004/up TI=05°C	-	90	-	nS
Reverse Recovery Charge	Qrr	I _S =100A, di/dt=100A/us, TJ=25℃	-	289	-	nC

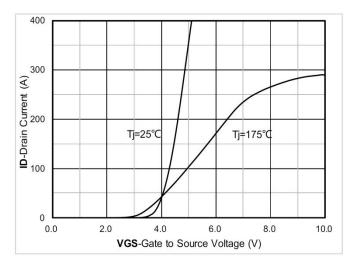
Note:

1. The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 Ω

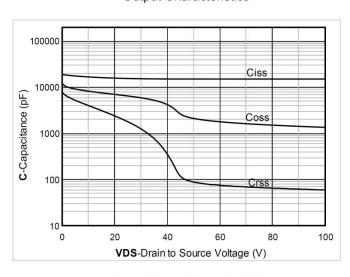
100V N-Channel Power MOSFET

Typical Characteristics

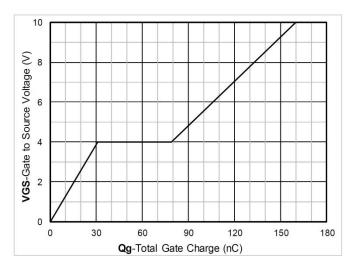




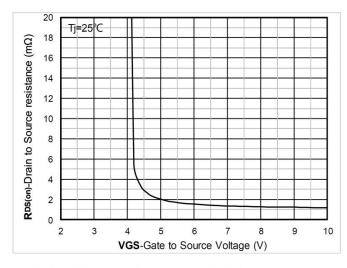
Output Characteristics



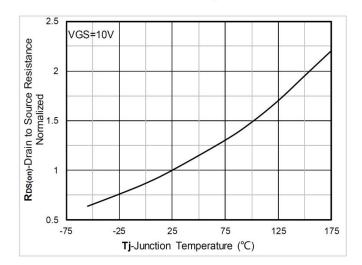
Transfer Characteristics



Capacitance Characteristics



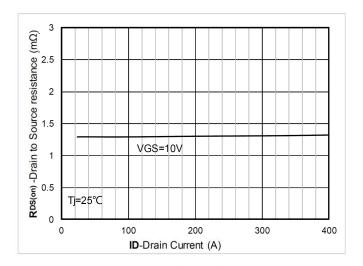
Gate Charge

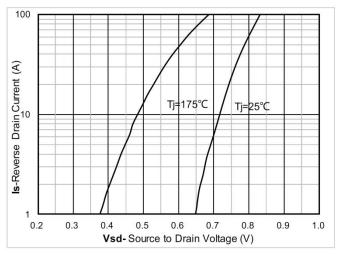


On-Resistance vs Gate to Source Voltage

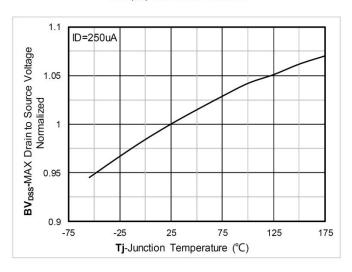
Normalized On-Resistance



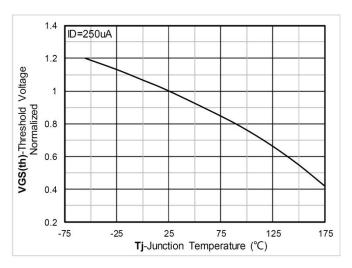




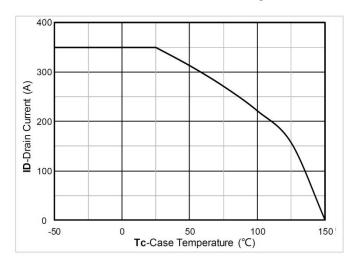
RDS(on) VS Drain Current



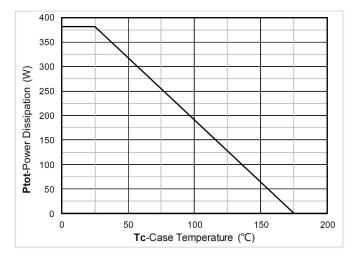
Forward characteristics of reverse diode



Normalized breakdown voltage

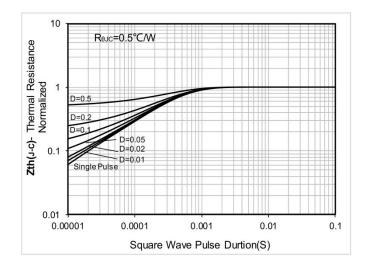


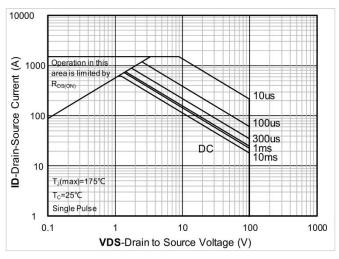
Normalized Threshold voltage



Current dissipation

Power dissipation

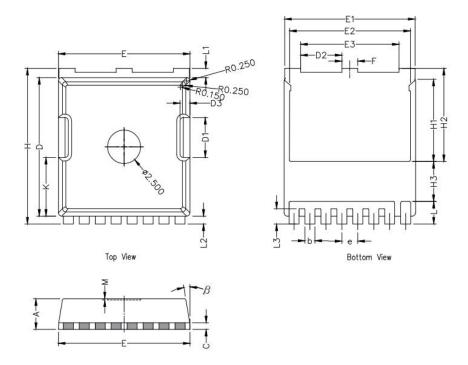




Maximum Transient Thermal Impedance

Safe Operation Area

TOLL Package Information



Symbol	Dimensions In Millimeters				
	Min.	Nom.	Max.		
А	2.20	2.30	2.40		
b	0.65	0.75	0.85		
С		0.508 REF			
D	10.25	10.40	10.55		
D1	2.85	3.00	3.15		
E	9.75	9.90	10.05		
E1	9.65	9.80	9.95		
E2	8.95	9.10	9.25		
E3	7.25	7.40	7.55		
е	1.20 BSC				
F	1.05	1.20	1.35		
Н	11.55	11.70	11.85		
H1	6.03	6.18	6.33		
H2	6.85	7.00	7.15		
H3	3.00 BSC				
L	1.55	1.70	1.85		
L1	0.55	0.7	0.85		
L2	0.45	0.6	0.75		
М	0.08 REF.				
β	8°	10°	12°		
К	4.25	4.40	4.55		